

RECORD NO.

SUPPLEMENTARY PUBLIC DEED
FOR THE ISSUANCE OF BONDS UNDER THE DEBT SECURITIES PROGRAM
SERIES AF, SERIES AG, SERIES AH, AND SERIES AI
AGUAS ANDINAS S.A.
AS ISSUER
AND BANCO CHILE
AS BONDHOLDERS' REPRESENTATIVE
AND PAYING BANK

IN SANTIAGO, CHILE, on the day of January, two thousand twenty-five, before me, IVÁN TORREALBA ACEVEDO, Chilean, married, attorney-at-law, identity card number three million four hundred seventeen thousand nine hundred ninety dash five, Notary Public holding office at the Thirty-Third Notary Office of Santiago, located at Huérfanos Street number nine hundred seventy-nine, office five hundred one, appeared: **ROSA ANTONELA LAINO**, Argentine, married, economist, identity card number twenty-three million one hundred seventy-one thousand five hundred sixty-four dash nine; and **MIQUEL SANS VILLALONGA**, Spanish, married, Bachelor in Business Administration and Management, identity card number twenty-eight million three hundred fifty-four thousand eight hundred fifty-one dash one, both acting in representation, as shall be evidenced, of **AGUAS ANDINAS S.A.**, an open stock corporation, tax identification number sixty-one million eight hundred eight thousand dash five, all with address for these purposes at Avenida Presidente Balmaceda number one thousand three hundred ninety-eight, Municipality of Santiago, hereinafter also and indistinctly referred to as the "Issuer" or the "Company"; and, on the other hand, Ms. **VANESSA RINWALD**, German, married, Commercial Agent, national identity card number twenty-two million one hundred thirty thousand seven hundred ninety-nine dash two, and Mr. **CRISTÓBAL ALBERTO**

LARRAÍN SANTANDER, Chilean, single, commercial engineer, identity card number thirteen million four hundred seventy-three thousand five hundred fifty-seven dash zero, both acting in representation, as shall be evidenced, of **BANCO DE CHILE**, a banking stock corporation, tax identification number ninety-seven million four thousand dash five, all domiciled in this city, at Paseo Ahumada Street number two hundred fifty-one, Municipality of Santiago, hereinafter also and indistinctly referred to as the "Bank", the "Paying Bank", the "Bondholders' Representative", or the "Representative"; all the appearing parties and representatives being of legal age, who proved their identities with the aforementioned identity cards, and declare as follows: **CLAUSE ONE.**

BACKGROUND AND DEFINITIONS. One. Background. (a) By public deed executed at this Notary Office on January second, two thousand twenty-five (hereinafter the "**Issuance Agreement**"), a thirty-year line was established (hereinafter the "**Bond Line**" or the "**Line**"), under which the Issuer, in accordance with the provisions of Article 104 and following of the Securities Market Law and other applicable regulations issued by the Financial Market Commission, may issue, in one or more series (and within each series, in sub-series), Bonds intended for the general market, up to a maximum amount of ten million Inflation-indexed Units (Unidades de Fomento). The aforementioned Line was registered in the Securities Registry of the Financial Market Commission under number

on January, two thousand twenty-five. (b) It is hereby expressly stated that, this being the first issuance under the Line, as of the date of this deed, there are no bonds outstanding under the Line. **Two. Definitions.** Capitalized terms not defined in this instrument shall have the meanings set forth in the Issuance Agreement. Each such meaning shall apply equally to both the singular and plural form of the corresponding term.

CLAUSE TWO. ISSUANCE OF SERIES AF BONDS. TERMS AND CONDITIONS OF THE ISSUANCE. **One. Issuance.** Pursuant to Clause One, by means of this instrument, the Issuer agrees to issue, under the Issuance Agreement, a series of bonds called Series AF (hereinafter, the "Series AF"), under the Bond Line. The terms and conditions of the Series AF Bonds are those set forth in this Supplementary Deed and in the Issuance Agreement. The provisions of the Issuance Agreement shall apply in all matters not expressly regulated in this Supplementary Deed. **Two. Characteristics of the Series AF Bonds.** (a) **Amount to be placed.** The Series AF contemplates Bonds for a nominal value of up to **eight million Inflation-indexed Units (Unidades de Fomento)**. The Series AF

Bonds shall be denominated in Inflation-indexed Units, and therefore, their amount shall be adjusted according to the variation in the value of the inflation-indexed unit and shall be payable in its equivalent in Chilean Pesos (CLP) on the maturity date of the respective coupon. For such purposes, the publications of the value of the inflation-indexed unit made in the Official Gazette by the Central Bank of Chile pursuant to paragraph nine of Article thirty-five of Law No. 18.840, or the body that replaces or succeeds it for such purposes, shall be considered valid. It is expressly stated that the Issuer may only place bonds for a maximum total nominal value of up to eight million Inflation-indexed Units, jointly considering the Series AF, AG, AH, and AI Bonds issued by virtue of this Supplementary Deed. **(b) Series of the Issuance and numbering of the bonds.** The Bonds of this issuance are issued in a single series called "Series AF". The Series AF Bonds shall be numbered from one to sixteen thousand, both inclusive. **(c) Number of Bonds.** The Series AF comprises a total of sixteen thousand Bonds. **(d) Nominal value of each Bond.** Each Series AF Bond has a nominal value of five hundred Inflation-indexed Units. **(e) Placement period of the Bonds.** The placement period for the Series AF Bonds shall be twelve months from the date of issuance of the official letter by which the Financial Market Commission authorizes the issuance of the Series AF Bonds. Bonds not placed within such period shall become null and void. **(f) Maturity date of the Bonds.** The Series AF Bonds shall mature on January fifteenth, two thousand thirty. **(g) Interest rate.** The Series AF Bonds shall accrue, on the outstanding principal amount denominated in Inflation-indexed Units, an annual compound interest rate of three point five zero percent (3.50%), calculated on the basis of equal six-month periods of one hundred eighty days, equivalent to a semiannual rate of one point seven three four nine percent (1.7349%). Interest shall accrue from January fifteenth, two thousand twenty-five and shall be payable on the dates indicated in the Amortization Schedule referred to in letter (h) below. **(h) Coupons and Amortization Schedule.** The Series AF Bonds regulated in this Supplementary Deed shall include ten coupons for the payment of interest and principal amortizations, the first nine of which shall be for interest payments, and the last one for both interest and principal amortization. It is noted that, since this is a dematerialized issuance, said coupons do not have physical or material existence, and are only referential for the payment of the respective installments. The payment procedure shall be carried out in accordance with the provisions of the Issuance Agreement and the

Internal Regulations of the DCV. The interest and principal payment dates, as well as the corresponding payment amounts, are those set forth in the Amortization Schedule of the Series AF Bonds, which is protocolized together with this instrument as Annex A, and which, for all legal purposes, shall be deemed an integral part of this Supplementary Deed. If the scheduled interest or principal payment dates do not fall on a Banking Business Day, the respective payment shall be made on the next Banking Business Day. Any unpaid interest, adjustments, or principal amounts not collected on their respective due dates shall not accrue further interest or adjustments beyond the due date, except in the event of default by the Issuer, in which case the unpaid amounts shall accrue, as permitted by Article sixteen of Law No. 18.010 on money credit operations, the maximum interest rate allowed by law for inflation-adjustable obligations in national currency, from the date of default until the effective payment of such amounts. Likewise, any delay on the part of the Bondholder in collecting any installment or coupon shall not constitute default or delay by the Issuer in the payment of principal, interest, or adjustments. **(i) Extraordinary amortization dates or periods.** The Issuer may redeem the Series AF Bonds early, in whole or in part, as of January fifteenth, two thousand twenty-eight, in accordance with the procedure described in number One, letter (A), item (ii) of Clause Seven of the Issuance Agreement. For the purpose of calculating the Prepayment Rate, the Prepayment Spread shall be seventy basis points. **(j) Use of Funds.** The funds obtained from the placement of the Series AF Bonds shall be used for the payment and/or prepayment of short- or long-term liabilities of the Issuer and/or its subsidiaries, regardless of whether such liabilities are denominated in national or foreign currency, and for financing the investments of the Issuer and/or its subsidiaries. **CLAUSE THREE.**

ISSUANCE OF SERIES AG BONDS. TERMS AND CONDITIONS OF THE ISSUANCE.

One. Issuance. Pursuant to the foregoing, by means of this instrument, the Issuer agrees to issue, under the Issuance Agreement, a series of bonds called Series AG (hereinafter, the "Series AG"), under the Bond Line. The terms and conditions of the Series AG Bonds are those set forth in this Supplementary Deed and in the Issuance Agreement. The provisions of the Issuance Agreement shall apply in all matters not expressly regulated in this Supplementary Deed. **Two. Characteristics of the Series AG Bonds. (a) Amount to be placed.** The Series AG contemplates Bonds for a nominal value of up to **eight million Inflation-indexed Units (UF)**. The Series AG Bonds shall be denominated in

Inflation-indexed Units and, therefore, their amount shall be adjusted according to the variation in the value of the inflation-indexed unit, and shall be payable in its equivalent in Chilean Pesos on the maturity date of the respective coupon. For such purposes, the publications of the value of the inflation-indexed unit (Unidad de Fomento) made in the Official Gazette by the Central Bank of Chile pursuant to paragraph nine of Article thirty-five of Law No. 18.840, or the body that replaces or succeeds it for such purposes, shall be considered valid. It is expressly stated that the Issuer may only place bonds for a maximum total nominal value of up to **eight million Inflation-indexed Units (UF)**, jointly considering the Series AF, AG, AH, and AI Bonds issued by virtue of this Supplementary Deed. **(b) Series of the Issuance and numbering of the bonds.** The Bonds of this issuance are issued in a single series called "Series AG". The Series AG Bonds shall be numbered from one to sixteen thousand, both inclusive. **(c) Number of Bonds.** The Series AG comprises a total of sixteen thousand Bonds. **(d) Nominal value of each Bond.** Each Series AG Bond has a nominal value of five hundred Inflation-indexed Units. **(e) Placement period of the Bonds.** The placement period for the Series AG Bonds shall be twelve months from the date of issuance of the official letter by which the Financial Market Commission authorizes the issuance of the Series AG Bonds. Bonds not placed within such period shall become null and void. **(f) Maturity date of the Bonds.** The Series AG Bonds shall mature on January fifteenth, two thousand thirty-five. **(g) Interest rate.** The Series AG Bonds shall accrue, on the outstanding principal amount denominated in Inflation-indexed Units, an annual compound interest rate of three point six zero percent (3.60%), calculated on the basis of equal six-month periods of one hundred eighty days, equivalent to a semiannual rate of one point seven eight four one percent (1.7841%). Interest shall accrue from January fifteenth, two thousand twenty-five and shall be payable on the dates indicated in the Amortization Schedule referred to in letter (h) below. **(h) Coupons and Amortization Schedule.** The Series AG Bonds regulated in this Supplementary Deed shall include twenty coupons for the payment of interest and principal amortizations, the first sixteen of which shall be for interest payments, and the last four for both interest and principal amortization. It is noted that, since this is a dematerialized issuance, said coupons do not have physical or material existence and are only referential for the payment of the respective installments. The payment procedure shall be carried out in accordance with the provisions of the Issuance Agreement and the

Internal Regulations of the DCV. The interest and principal payment dates, as well as the corresponding payment amounts, are those set forth in the Amortization Schedule of the Series AG Bonds, which is protocolized together with this instrument as Annex B, and which, for all legal purposes, shall be deemed an integral part of this Supplementary Deed. If the scheduled interest or principal payment dates do not fall on a Banking Business Day, the respective payment shall be made on the next Banking Business Day. Any unpaid interest or principal amounts not collected on their respective due dates shall not accrue further interest beyond the due date, except in the event of default by the Issuer, in which case the unpaid amounts shall accrue, as permitted by Article sixteen of Law No. 18.010 on money credit operations, the maximum interest rate allowed by law for inflation-adjustable obligations in national currency, from the date of default until the effective payment of such amounts. Likewise, any delay on the part of the Bondholder in collecting any installment or coupon shall not constitute default or delay by the Issuer in the payment of principal or interest. **(i) Extraordinary amortization dates or periods.** The Issuer may redeem the Series AG Bonds early, in whole or in part, as of January fifteenth, two thousand twenty-eight, in accordance with the procedure described in number One, letter (A), item (ii) of Clause Seven of the Issuance Agreement. For the purpose of calculating the Prepayment Rate, the Prepayment Spread shall be seventy basis points. **(j) Use of Funds.** The funds obtained from the placement of the Series AG Bonds shall be used for the payment and/or prepayment of short- or long-term liabilities of the Issuer and/or its subsidiaries, regardless of whether such liabilities are denominated in national or foreign currency, and for financing the investments of the Issuer and/or its subsidiaries. **CLAUSE FOUR. ISSUANCE OF SERIES AH BONDS. TERMS AND CONDITIONS OF THE ISSUANCE.** **One. Issuance.** Pursuant to Clause One, by means of this instrument, the Issuer agrees to issue, under the Issuance Agreement, a series of bonds called Series AH (hereinafter, the "Series AH"), under the Bond Line. The terms and conditions of the Series AH Bonds are those set forth in this Supplementary Deed and in the Issuance Agreement. The provisions of the Issuance Agreement shall apply in all matters not expressly regulated in this Supplementary Deed. **Two. Characteristics of the Series AH Bonds.** **(a) Amount to be placed.** The Series AH contemplates Bonds for a nominal value of up to eight million Inflation-indexed Units. The Series AH Bonds shall be denominated in Inflation-indexed Units and, therefore, their amount shall be adjusted

according to the variation in the value of the inflation-indexed unit and shall be payable in its equivalent in Chilean Pesos on the maturity date of the respective coupon. For such purposes, the publications of the value of the inflation-indexed unit made in the Official Gazette by the Central Bank of Chile pursuant to paragraph nine of Article thirty-five of Law No. 18.840, or the body that replaces or succeeds it for such purposes, shall be considered valid. It is expressly stated that the Issuer may only place bonds for a maximum total nominal value of up to eight million Inflation-indexed Units, jointly considering the Series AF, AG, AH, and AI Bonds issued by virtue of this Supplementary Deed. **(b) Series of the Issuance and numbering of the bonds.** The Bonds of this issuance are issued in a single series called "Series AH". The Series AH Bonds shall be numbered from one to sixteen thousand, both inclusive. **(c) Number of Bonds.** The Series AH comprises a total of sixteen thousand Bonds. **(d) Nominal value of each Bond.** Each Series AH Bond has a nominal value of five hundred Inflation-indexed Units. **(e) Placement period of the Bonds.** The placement period for the Series AH Bonds shall be twelve months from the date of issuance of the official letter by which the Financial Market Commission authorizes the issuance of the Series AH Bonds. Bonds not placed within such period shall become null and void. **(f) Maturity date of the Bonds.** The Series AH Bonds shall mature on January fifteenth, two thousand forty-six. **(g) Interest rate.** The Series AH Bonds shall accrue, on the outstanding principal amount denominated in Inflation-indexed Units, an annual compound interest rate of three point four zero percent (3.40%), calculated on the basis of equal six-month periods of one hundred eighty days, equivalent to a semiannual rate of one point six eight five eight percent (1.6858%). Interest shall accrue from January fifteenth, two thousand twenty-five and shall be payable on the dates indicated in the Amortization Schedule referred to in letter (h) below. **(h) Coupons and Amortization Schedule.** The Series AH Bonds regulated in this Supplementary Deed shall include forty-two coupons for the payment of interest and principal amortizations, the first thirty-eight of which shall be for interest payments, and the last four for both interest and principal amortization. It is noted that, since this is a dematerialized issuance, said coupons do not have physical or material existence and are only referential for the payment of the respective installments. The payment procedure shall be carried out in accordance with the provisions of the Issuance Agreement and the Internal Regulations of the DCV. The interest and principal payment dates, as well as the

corresponding payment amounts, are those set forth in the Amortization Schedule of the Series AH Bonds, which is protocolized together with this instrument as Annex C, and which, for all legal purposes, shall be deemed an integral part of this Supplementary Deed. If the scheduled interest or principal payment dates do not fall on a Banking Business Day, the respective payment shall be made on the next Banking Business Day. Any unpaid interest, adjustments, or principal amounts not collected on their respective due dates shall not accrue further interest or adjustments beyond the due date, except in the event of default by the Issuer, in which case the unpaid amounts shall accrue, as permitted by Article sixteen of Law No. 18.010 on money credit operations, the maximum interest rate allowed by law for inflation-adjustable obligations in national currency, from the date of default until the effective payment of such amounts. Likewise, any delay on the part of the Bondholder in collecting any installment or coupon shall not constitute default or delay by the Issuer in the payment of principal, interest, or adjustments. **(i) Extraordinary amortization dates or periods.** The Issuer may redeem the Series AH Bonds early, in whole or in part, as of January fifteenth, two thousand twenty-eight, in accordance with the procedure described in number One, letter (A), item (ii) of Clause Seven of the Issuance Agreement. For the purpose of calculating the Prepayment Rate, the Prepayment Spread shall be seventy basis points. **(j) Use of Funds.** The funds obtained from the placement of the Series AH Bonds shall be used for the payment and/or prepayment of short- or long-term liabilities of the Issuer and/or its subsidiaries, regardless of whether such liabilities are denominated in national or foreign currency, and for financing the investments of the Issuer and/or its subsidiaries. **CLAUSE FIVE. ISSUANCE OF SERIES AI BONDS. TERMS AND CONDITIONS OF THE ISSUANCE.** **One. Issuance.** Pursuant to the provisions of Clause One, by means of this instrument, the Issuer agrees to issue, under the Issuance Agreement, a series of bonds called Series AI (hereinafter, the "Series AI"), under the Bond Line. The terms and conditions of the Series AI Bonds are those set forth in this Supplementary Deed and in the Issuance Agreement. The provisions of the Issuance Agreement shall apply in all matters not expressly regulated in this Supplementary Deed. **Two. Characteristics of the Series AI Bonds.** **(a) Amount to be placed.** The Series AI contemplates Bonds for a nominal value of up to **eight million Inflation-indexed Units (UF)**. The Series AI Bonds shall be denominated in Inflation-indexed Units and, therefore, their amount shall be adjusted according to the

variation in the value of the Inflation-indexed Unit and shall be payable in its equivalent in Chilean Pesos (CLP) on the maturity date of the respective coupon. For these purposes, the publications of the value of the Inflation-indexed Unit made in the Official Gazette by the Central Bank of Chile pursuant to paragraph nine of Article thirty-five of Law No. 18.840, or the body that replaces or succeeds it for such purposes, shall be considered valid. It is expressly stated that the Issuer may only place bonds for a maximum total nominal value of up to **eight million Inflation-indexed Units**, jointly considering the Series AF, AG, AH, and AI Bonds issued by virtue of this Supplementary Deed. **(b) Series of the Issuance and numbering of the bonds.** The Bonds of this issuance are issued in a single series called "Series AI". The Series AI Bonds shall be numbered from one to sixteen thousand, both inclusive. **(c) Number of Bonds.** The Series AI comprises a total of sixteen thousand Bonds. **(d) Nominal value of each Bond.** Each Series AI Bond has a nominal value of five hundred Inflation-indexed Units. **(e) Placement period of the Bonds.** The placement period for the Series AI Bonds shall be twelve months from the date of issuance of the official letter by which the Financial Market Commission authorizes the issuance of the Series AI Bonds. Bonds not placed within such period shall become null and void. **(f) Maturity date of the Bonds.** The Series AI Bonds shall mature on January fifteenth, two thousand fifty. **(g) Interest rate.** The Series AI Bonds shall accrue, on the outstanding principal amount denominated in Inflation-indexed Units, an annual compound interest rate of three point four zero percent (3.40%), calculated on the basis of equal six-month periods of one hundred eighty days, equivalent to a semiannual rate of one point six eight five eight percent (1.6858%). Interest shall accrue from January fifteenth, two thousand twenty-five and shall be payable on the dates indicated in the Amortization Schedule referred to in letter (h) below. **(h) Coupons and Amortization Schedule.** The Series AI Bonds regulated in this Supplementary Deed shall include fifty coupons for the payment of interest and principal amortizations, the first forty-six of which shall be for interest payments, and the last four for both interest and principal amortization. It is noted that, since this is a dematerialized issuance, said coupons do not have physical or material existence and are only referential for the payment of the respective installments. The payment procedure shall be carried out in accordance with the provisions of the Issuance Agreement and the Internal Regulations of the DCV. The interest and principal payment dates, as well as the corresponding payment amounts, are

those set forth in the Amortization Schedule of the Series AI Bonds, which is protocolized together with this instrument as Annex D, and which, for all legal purposes, shall be deemed an integral part of this Supplementary Deed. If the scheduled interest or principal payment dates do not fall on a Banking Business Day, the respective payment shall be made on the next Banking Business Day. Any unpaid interest, adjustments, or principal amounts not collected on their respective due dates shall not accrue further interest or adjustments beyond the due date, except in the event of default by the Issuer, in which case the unpaid amounts shall accrue, as permitted by Article sixteen of Law No. 18.010 on money credit operations, the maximum interest rate allowed by law for inflation-adjustable obligations in national currency, from the date of default until the effective payment of such amounts. Likewise, any delay on the part of the Bondholder in collecting any installment or coupon shall not constitute default or delay by the Issuer in the payment of principal, interest, or adjustments. **(i) Extraordinary amortization dates or periods.** The Issuer may redeem the Series AI Bonds early, in whole or in part, as of January fifteenth, two thousand twenty-eight, in accordance with the procedure described in number One, letter (A), item (ii) of Clause Seven of the Issuance Agreement. For the purpose of calculating the Prepayment Rate, the Prepayment Spread shall be seventy basis points. **(j) Use of Funds.** The funds obtained from the placement of the Series AI Bonds shall be used for the payment and/or prepayment of short- or long-term liabilities of the Issuer and/or its subsidiaries, regardless of whether such liabilities are denominated in national or foreign currency, and for financing the investments of the Issuer and/or its subsidiaries. **CLAUSE SIX. PLACEMENT AGENT.** For the purposes of this issuance, Scotia Corredora de Bolsa Chile Limitada and Santander Corredores de Bolsa Limitada shall act as Placement Agents. These entities have no relationship with the Issuer. **CLAUSE SEVEN. TAX REGIME.** The Series AF Bonds, Series AG Bonds, Series AH Bonds, and Series AI Bonds are subject to the tax benefit established in Article 104 of the Income Tax Law, contained in Decree Law No. 824 of 1974 and its amendments, provided that all acts, requirements, and conditions set forth in said Article have been verified and fulfilled. For these purposes, in addition to the coupon or face rate, the Issuer shall determine, after each placement, a fiscal interest rate for the purposes of calculating accrued interest, as provided in subsection one of said Article 104. The fiscal interest rate shall be reported by the Issuer on the same day the respective placement is carried out,

to the CMF, the stock exchanges, and securities intermediaries. It is expressly stated that, in accordance with the final paragraph of Article 74, item 7, of the Income Tax Law, the Issuer is exempt from the withholding obligation set forth in said item. The withholding must be carried out as indicated in item 8 of the same Article. Taxpayers without domicile or residence in Chile must appoint or designate a representative, custodian, intermediary, securities depository, or another person domiciled or incorporated in the country, who shall be responsible for complying with their applicable tax obligations. **CLAUSE EIGHT.**

SUPPLEMENTARY RULES. Any matters not regulated in this Supplemental Indenture shall be governed by the provisions of the Bond Indenture. **CLAUSE NINE. DOMICILE.**

For all purposes of this instrument, the parties establish their domicile in the municipal district of Santiago and submit to the jurisdiction of its courts. **AUTHORITY:** The authority of the representatives of AGUAS ANDINAS S.A. is evidenced by a public deed dated January 2, 2025, executed before the Notary Public of Santiago, Ms. Nancy de la Fuente Hernández. The authority of the representatives of BANCO DE CHILE is evidenced by public deeds dated July 1, 2019, and March 27, 2014, both executed before the Notary Public of Santiago, Mr. René Benavente Cash. These authorities are not inserted herein as they are known to the parties and to the Notary Public who attests to this document. In witness whereof, and after having read it, the appearing parties sign this deed. A copy is issued, and the deed is recorded in the Repertory Book under the number stated above.

I hereby certify.

ROSA ANTONELA LAINO

pp. AGUAS ANDINAS S.A.

MIQUEL SANS VILLALONGA

pp. AGUAS ANDINAS S.A.

VANESSA RINWALD

pp. BANCO CHILE

CRISTÓBAL ALBERTO LARRAIN SANTANDER

pp. BANCO CHILE

Annex A

REPAYMENT SCHEDULE

Aguas Andinas S.A.
Series AF

Nominal value	UF 500
Number of bonds	16,000
Interest	Semiannual
Interest Accrual Start Date	01/15/2025
Maturity Date	01/15/2030
Annual Interest Rate	3.5000%
Semiannual Interest Rate	1.7349%

Coupon	Interest Installment	Principal Installment	Maturity Date	Interest	Principal	Installment Value	Outstanding Principal Balance
1	1		07/15/2025	8.6745	0.0000	8.6745	500.0000
2	2		01/15/2026	8.6745	0.0000	8.6745	500.0000
3	3		07/15/2026	8.6745	0.0000	8.6745	500.0000
4	4		01/15/2027	8.6745	0.0000	8.6745	500.0000
5	5		07/15/2027	8.6745	0.0000	8.6745	500.0000
6	6		01/15/2028	8.6745	0.0000	8.6745	500.0000
7	7		07/15/2028	8.6745	0.0000	8.6745	500.0000
8	8		01/15/2029	8.6745	0.0000	8.6745	500.0000
9	9		07/15/2029	8.6745	0.0000	8.6745	500.0000
10	10	1	01/15/2030	8.6745	500.0000	508.6745	0.0000

Annex B

REPAYMENT SCHEDULE

Aguas Andinas S.A.
Series AG

Nominal value	UF 500
Number of bonds	16,000
Interest	Semiannual
Interest Accrual Start Date	01/15/2025
Maturity Date	01/15/2035
Annual Interest Rate	3.6000%
Semiannual Interest Rate	1.7841%

Coupon	Interest Installment	Principal Installment	Maturity Date	Interest	Principal	Installment Value	Outstanding Principal Balance
1	1		07/15/2025	8.9205	0.0000	8.9205	500.0000
2	2		01/15/2026	8.9205	0.0000	8.9205	500.0000
3	3		07/15/2026	8.9205	0.0000	8.9205	500.0000
4	4		01/15/2027	8.9205	0.0000	8.9205	500.0000
5	5		07/15/2027	8.9205	0.0000	8.9205	500.0000
6	6		01/15/2028	8.9205	0.0000	8.9205	500.0000
7	7		07/15/2028	8.9205	0.0000	8.9205	500.0000
8	8		01/15/2029	8.9205	0.0000	8.9205	500.0000
9	9		07/15/2029	8.9205	0.0000	8.9205	500.0000
10	10		01/15/2030	8.9205	0.0000	8.9205	500.0000
11	11		07/15/2030	8.9205	0.0000	8.9205	500.0000
12	12		01/15/2031	8.9205	0.0000	8.9205	500.0000
13	13		07/15/2031	8.9205	0.0000	8.9205	500.0000
14	14		01/15/2032	8.9205	0.0000	8.9205	500.0000
15	15		07/15/2032	8.9205	0.0000	8.9205	500.0000
16	16		01/15/2033	8.9205	0.0000	8.9205	500.0000
17	17	1	07/15/2033	8.9205	125.0000	133.9205	375.0000
18	18	2	01/15/2034	6.6904	125.0000	131.6904	250.0000
19	19	3	07/15/2034	4.4603	125.0000	129.4603	125.0000
20	20	4	01/15/2035	2.2301	125.0000	127.2301	0.0000

Annex C

REPAYMENT SCHEDULE

Aguas Andinas S.A.
Series AH

Nominal value	UF 500
Number of bonds	16,000
Interest	Semiannual
Interest Accrual Start Date	01/15/2025
Maturity Date	01/15/2046
Annual Interest Rate	3.4000%
Semiannual Interest Rate	1.6858%

Coupon	Interest Installment	Principal Installment	Maturity Date	Interest	Principal	Installment Value	Outstanding Principal Balance
1	1		07/15/2025	8.4290	0.0000	8.4290	500.0000
2	2		01/15/2026	8.4290	0.0000	8.4290	500.0000
3	3		07/15/2026	8.4290	0.0000	8.4290	500.0000
4	4		01/15/2027	8.4290	0.0000	8.4290	500.0000
5	5		07/15/2027	8.4290	0.0000	8.4290	500.0000
6	6		01/15/2028	8.4290	0.0000	8.4290	500.0000
7	7		07/15/2028	8.4290	0.0000	8.4290	500.0000
8	8		01/15/2029	8.4290	0.0000	8.4290	500.0000
9	9		07/15/2029	8.4290	0.0000	8.4290	500.0000
10	10		01/15/2030	8.4290	0.0000	8.4290	500.0000
11	11		07/15/2030	8.4290	0.0000	8.4290	500.0000
12	12		01/15/2031	8.4290	0.0000	8.4290	500.0000
13	13		07/15/2031	8.4290	0.0000	8.4290	500.0000
14	14		01/15/2032	8.4290	0.0000	8.4290	500.0000
15	15		07/15/2032	8.4290	0.0000	8.4290	500.0000
16	16		01/15/2033	8.4290	0.0000	8.4290	500.0000
17	17		07/15/2033	8.4290	0.0000	8.4290	500.0000
18	18		01/15/2034	8.4290	0.0000	8.4290	500.0000
19	19		07/15/2034	8.4290	0.0000	8.4290	500.0000
20	20		01/15/2035	8.4290	0.0000	8.4290	500.0000
21	21		07/15/2035	8.4290	0.0000	8.4290	500.0000
22	22		01/15/2036	8.4290	0.0000	8.4290	500.0000
23	23		07/15/2036	8.4290	0.0000	8.4290	500.0000
24	24		01/15/2037	8.4290	0.0000	8.4290	500.0000
25	25		07/15/2037	8.4290	0.0000	8.4290	500.0000
26	26		01/15/2038	8.4290	0.0000	8.4290	500.0000
27	27		07/15/2038	8.4290	0.0000	8.4290	500.0000
28	28		01/15/2039	8.4290	0.0000	8.4290	500.0000
29	29		07/15/2039	8.4290	0.0000	8.4290	500.0000
30	30		01/15/2040	8.4290	0.0000	8.4290	500.0000
31	31		07/15/2040	8.4290	0.0000	8.4290	500.0000
32	32		01/15/2041	8.4290	0.0000	8.4290	500.0000
33	33		07/15/2041	8.4290	0.0000	8.4290	500.0000
34	34		01/15/2042	8.4290	0.0000	8.4290	500.0000
35	35		07/15/2042	8.4290	0.0000	8.4290	500.0000
36	36		01/15/2043	8.4290	0.0000	8.4290	500.0000
37	37		07/15/2043	8.4290	0.0000	8.4290	500.0000
38	38		01/15/2044	8.4290	0.0000	8.4290	500.0000
39	39	1	07/15/2044	8.4290	125.0000	133.4290	375.0000
40	40	2	01/15/2045	6.3218	125.0000	131.3218	250.0000
41	41	3	07/15/2045	4.2145	125.0000	129.2145	125.0000
42	42	4	01/15/2046	2.1073	125.0000	127.1073	0.0000

REPAYMENT SCHEDULE
Aguas Andinas S.A.
Series AI

Nominal value	UF 500
Number of bonds	16,000
Interest	Semiannual
Interest Accrual Start Date	01/15/2025
Maturity Date	01/15/2050
Annual Interest Rate	3.4000%
Semiannual Interest Rate	1.6858%

Coupon	Interest Installment	Principal Installment	Maturity Date	Interest	Principal	Installment Value	Outstanding Principal Balance
1	1		07/15/2025	8.4290	0.0000	8.4290	500.0000
2	2		01/15/2026	8.4290	0.0000	8.4290	500.0000
3	3		07/15/2026	8.4290	0.0000	8.4290	500.0000
4	4		01/15/2027	8.4290	0.0000	8.4290	500.0000
5	5		07/15/2027	8.4290	0.0000	8.4290	500.0000
6	6		01/15/2028	8.4290	0.0000	8.4290	500.0000
7	7		07/15/2028	8.4290	0.0000	8.4290	500.0000
8	8		01/15/2029	8.4290	0.0000	8.4290	500.0000
9	9		07/15/2029	8.4290	0.0000	8.4290	500.0000
10	10		01/15/2030	8.4290	0.0000	8.4290	500.0000
11	11		07/15/2030	8.4290	0.0000	8.4290	500.0000
12	12		01/15/2031	8.4290	0.0000	8.4290	500.0000
13	13		07/15/2031	8.4290	0.0000	8.4290	500.0000
14	14		01/15/2032	8.4290	0.0000	8.4290	500.0000
15	15		07/15/2032	8.4290	0.0000	8.4290	500.0000
16	16		01/15/2033	8.4290	0.0000	8.4290	500.0000
17	17		07/15/2033	8.4290	0.0000	8.4290	500.0000
18	18		01/15/2034	8.4290	0.0000	8.4290	500.0000
19	19		07/15/2034	8.4290	0.0000	8.4290	500.0000
20	20		01/15/2035	8.4290	0.0000	8.4290	500.0000
21	21		07/15/2035	8.4290	0.0000	8.4290	500.0000
22	22		01/15/2036	8.4290	0.0000	8.4290	500.0000
23	23		07/15/2036	8.4290	0.0000	8.4290	500.0000
24	24		01/15/2037	8.4290	0.0000	8.4290	500.0000
25	25		07/15/2037	8.4290	0.0000	8.4290	500.0000
26	26		01/15/2038	8.4290	0.0000	8.4290	500.0000
27	27		07/15/2038	8.4290	0.0000	8.4290	500.0000
28	28		01/15/2039	8.4290	0.0000	8.4290	500.0000
29	29		07/15/2039	8.4290	0.0000	8.4290	500.0000
30	30		01/15/2040	8.4290	0.0000	8.4290	500.0000
31	31		07/15/2040	8.4290	0.0000	8.4290	500.0000
32	32		01/15/2041	8.4290	0.0000	8.4290	500.0000
33	33		07/15/2041	8.4290	0.0000	8.4290	500.0000
34	34		01/15/2042	8.4290	0.0000	8.4290	500.0000
35	35		07/15/2042	8.4290	0.0000	8.4290	500.0000
36	36		01/15/2043	8.4290	0.0000	8.4290	500.0000
37	37		07/15/2043	8.4290	0.0000	8.4290	500.0000
38	38		01/15/2044	8.4290	0.0000	8.4290	500.0000
39	39		07/15/2044	8.4290	0.0000	8.4290	500.0000
40	40		01/15/2045	8.4290	0.0000	8.4290	500.0000
41	41		07/15/2045	8.4290	0.0000	8.4290	500.0000
42	42		01/15/2046	8.4290	0.0000	8.4290	500.0000
43	43		07/15/2046	8.4290	0.0000	8.4290	500.0000
44	44		01/15/2047	8.4290	0.0000	8.4290	500.0000
45	45		07/15/2047	8.4290	0.0000	8.4290	500.0000
46	46		01/15/2048	8.4290	0.0000	8.4290	500.0000
47	47	1	07/15/2048	8.4290	125.0000	133.4290	375.0000
48	48	2	01/15/2049	6.3218	125.0000	131.3218	250.0000
49	49	3	07/15/2049	4.2145	125.0000	129.2145	125.0000
50	50	4	01/15/2050	2.1073	125.0000	127.1073	0.0000

